



Performance of thin n-on-p planar pixel sensors for the ATLAS ITK

R. Taibah, M. Bomben, F. Crescioli, G. Calderini, L. D'Eramo

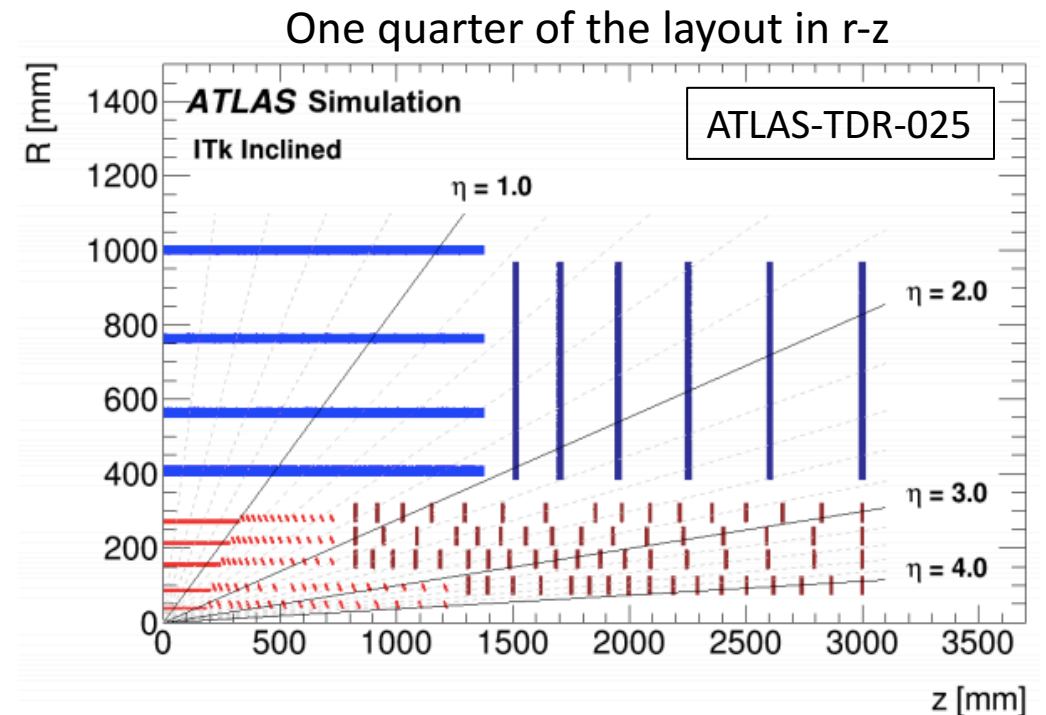
Trento 14th workshop for advanced silicon radiation detector

25-27 February 2019, Trento, Italy.



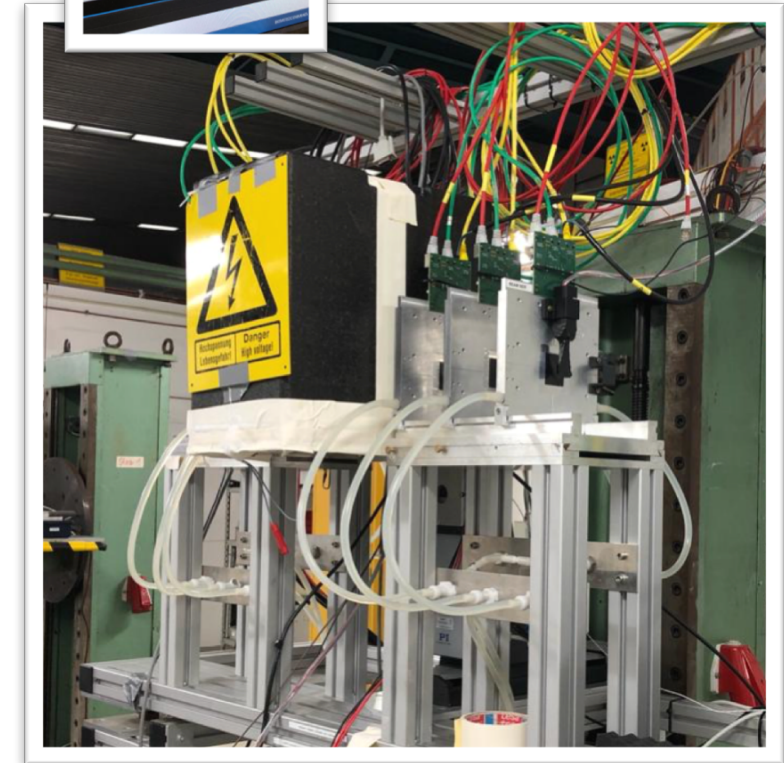
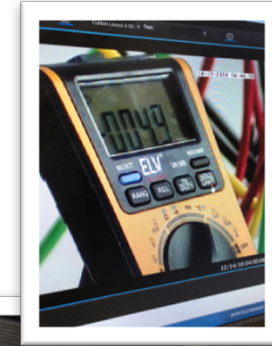
Introduction

- ATLAS detector upgrade for **High Luminosity phase (HL-LHC)** → $\mathcal{L}_{\text{instantaneous}} = 7.5 \times 10^{34} \text{ cm}^{-2}\text{s}^{-1}$.
- Inner detector replaced with new **all silicon Inner Tracker (pixels + strips)**.
- **ITK requirements** for silicon pixel detectors include:
 - **Higher granularity** → Smaller pitch pixels of $50 \times 50 \mu\text{m}^2$ or $25 \times 100 \mu\text{m}^2$.
 - **Radiation hardness** → up to $3 \times 10^{15} \text{ n}_{\text{eq}}/\text{cm}^2$ for planar sensors.
 - **Hit efficiency** > 97% for HL-LHC (at Max 600V)

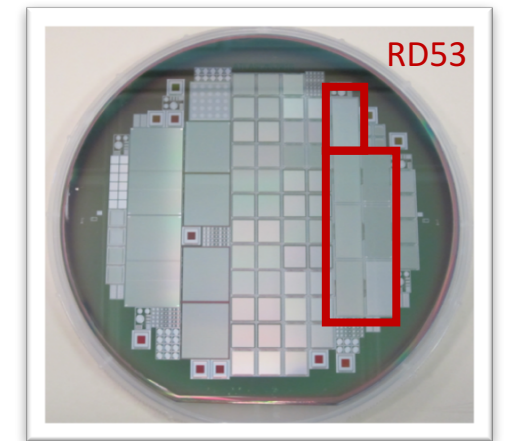


Setup

- Sensors are produced by FBK and assembled at IZM with the RD53a front-end on a single chip card.
- Presented modules were **Irradiated at CERN PS** Irrad facility.
- Modules were measured before and after irradiation in a **testbeam setup** at CERN (120 GeV pions) and DESY (5 GeV electrons) .
- Data acquisition setup include Mimosa telescope planes, scintillators for external trigger, Bdaq53 readout, cooling chamber for controlled temperatures at $-50\text{ }^{\circ}\text{C}$.
- Tracks **reconstruction using Eutelescope** and data is **analyzed using Tbson2** software.
- All modules were tuned before measurement to achieve lowest possible threshold ($\sim 1000e$).

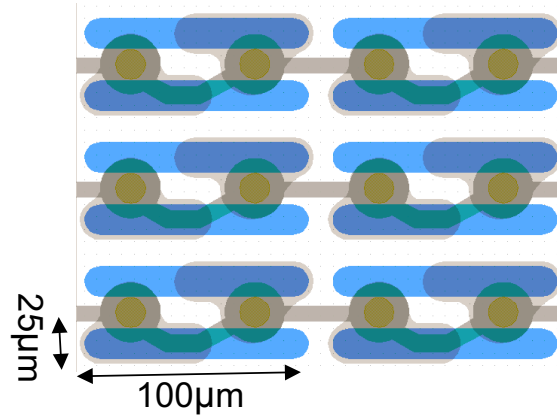


Modules overview



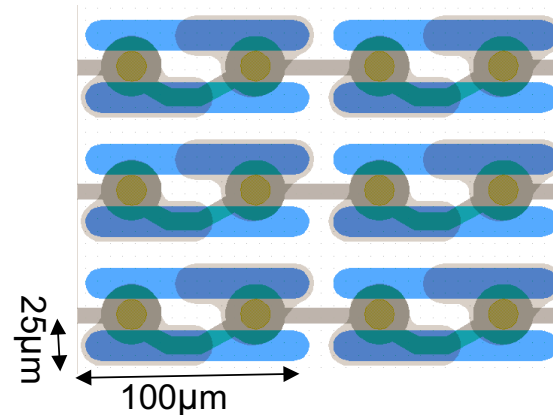
- RD53 n-in-p planar sensors are produced on 6" wafer by FBK.

Measured modules details:



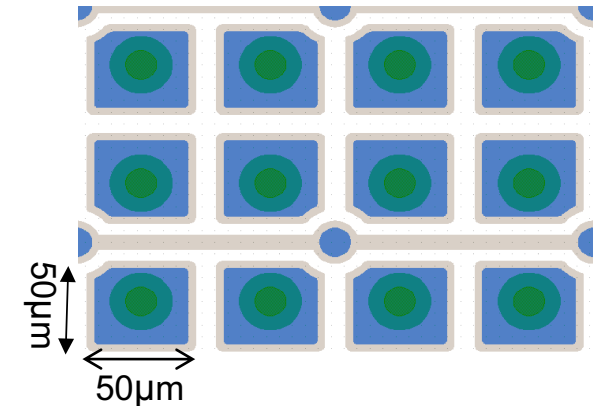
100-25-noPT

- thickness: 100µm
- cell: 25x100µm²
- No biasing dot
- **Not Irradiated**



130-25-noPT

- thickness: 130µm
- cell: 25x100µm²
- No biasing dot
- Irradiated at CERN PS



130-50-PT

- thickness: 130µm
- cell: 50x50µm²
- With biasing dot
- Irradiated at CERN PS

Results

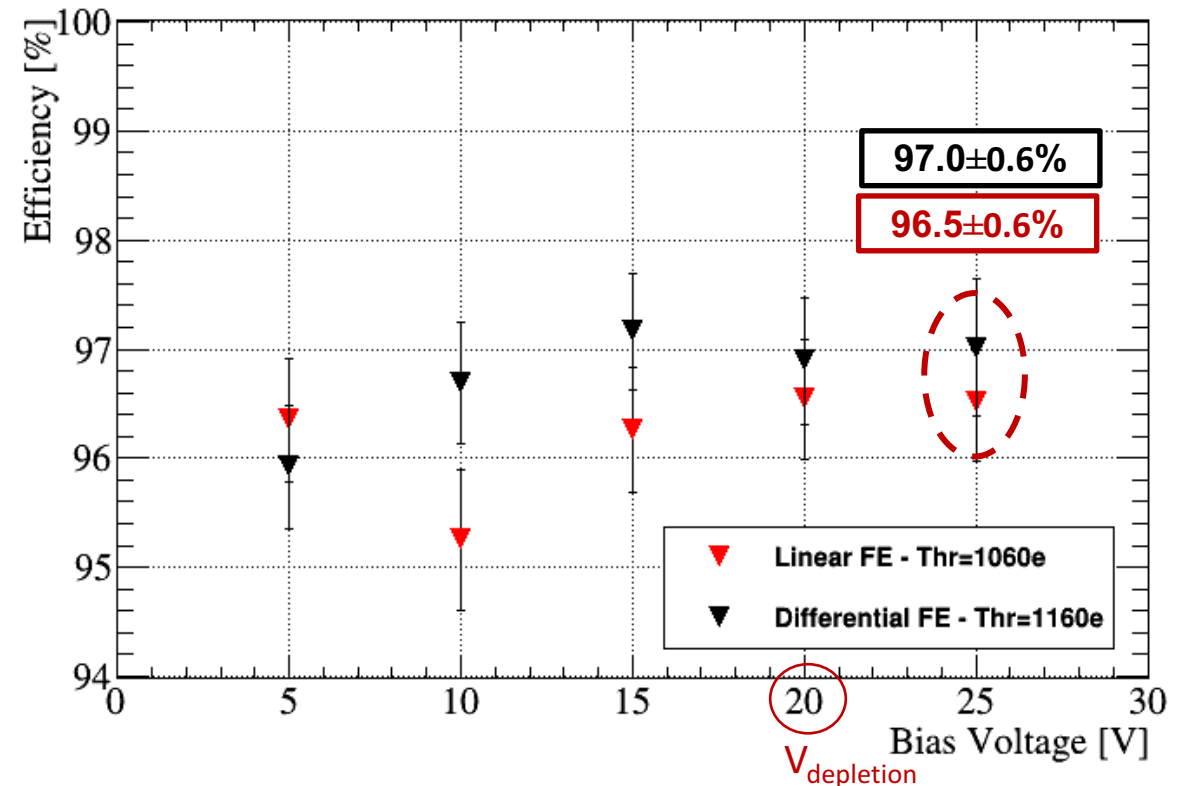
Non-Irradiated modules

Hit efficiency vs. bias voltage

- $25 \times 100 \mu\text{m}^2$ pixel module with $100 \mu\text{m}$ thick sensor, Non-irradiated.



- Tuned threshold:
 - Linear = 1060e
 - Differential = 1160e
- Depletion voltage for the sensor is $V_{\text{depletion}} = 20\text{V}$.
- Hit efficiency for Linear & Differential FE show similar results.

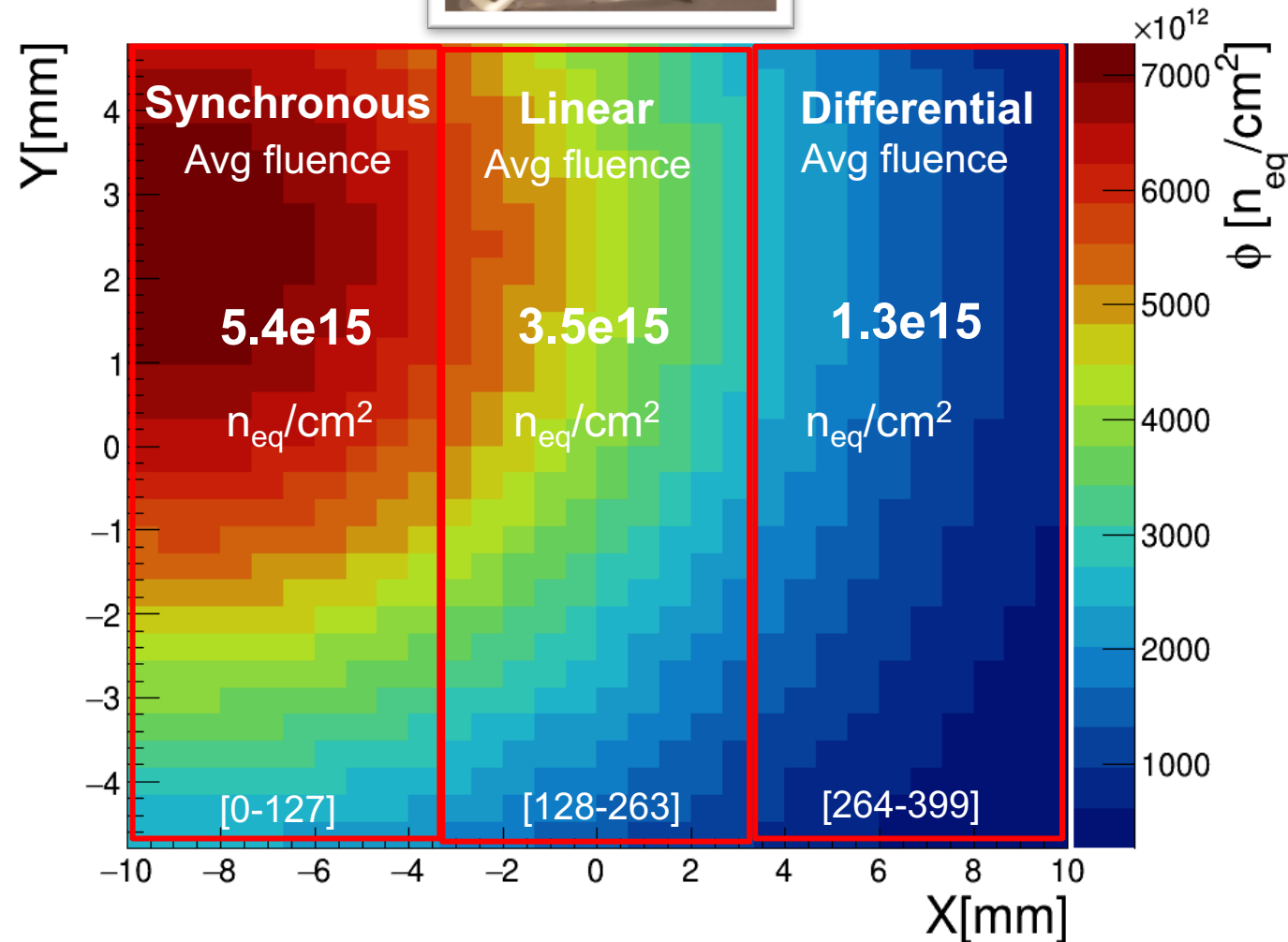
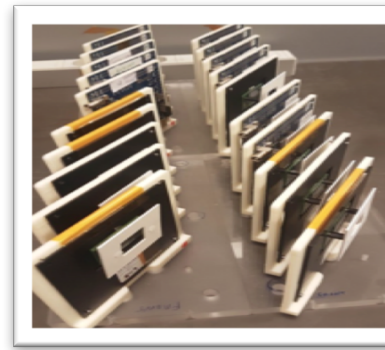


Results

Irradiated modules

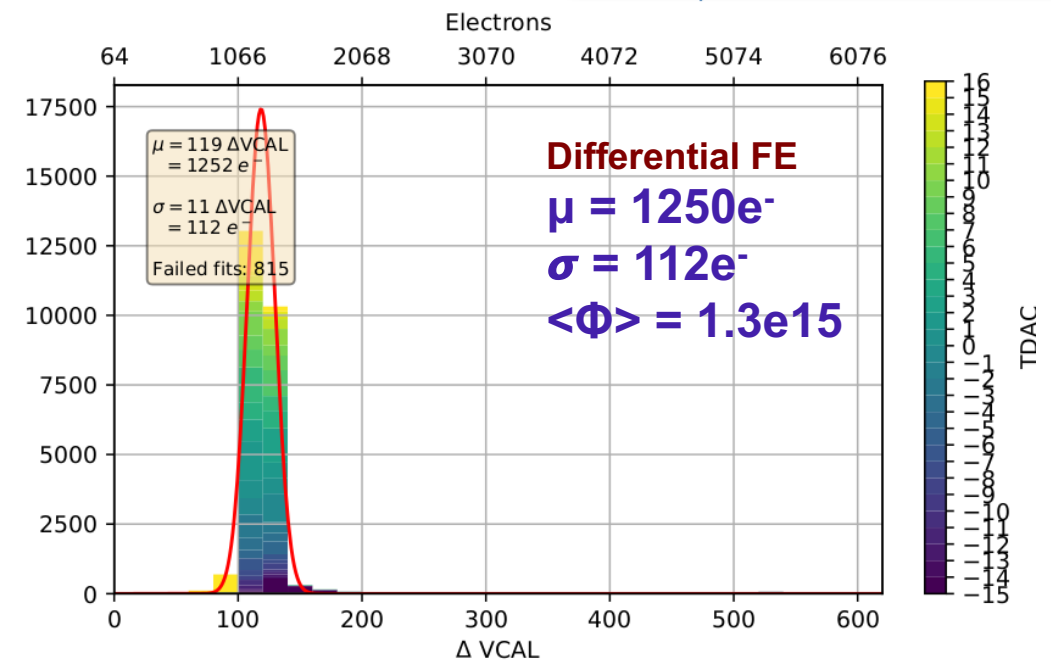
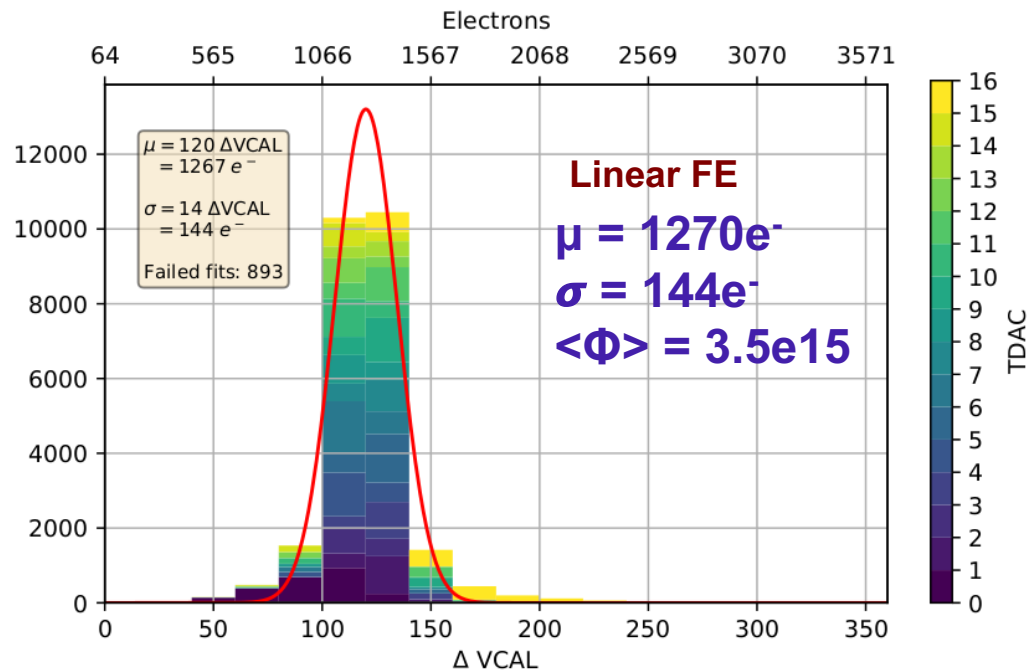
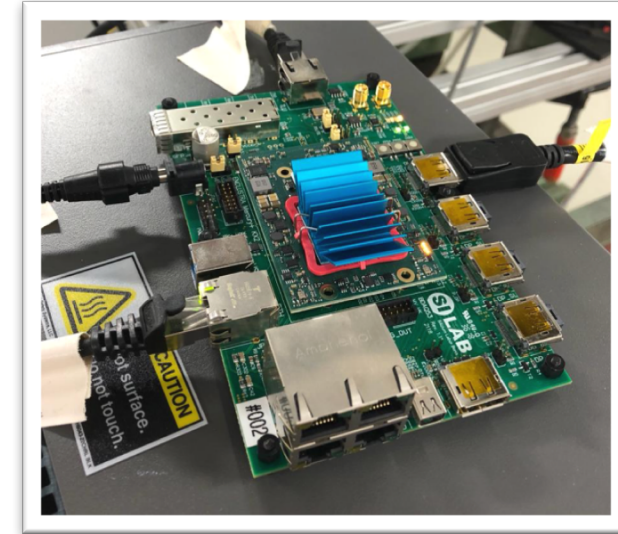
Module irradiation

- Irradiation at CERN PS Irrad facility → Inhomogeneous profile + irradiation beam misalignment.
- Fluence map is reconstructed from Beam Profile Monitor (BMP) with the dosimetry results measured on the foil sheet mounted behind the modules.
- Fluence analysis estimates **~20% uncertainty** from measurements and fitting.



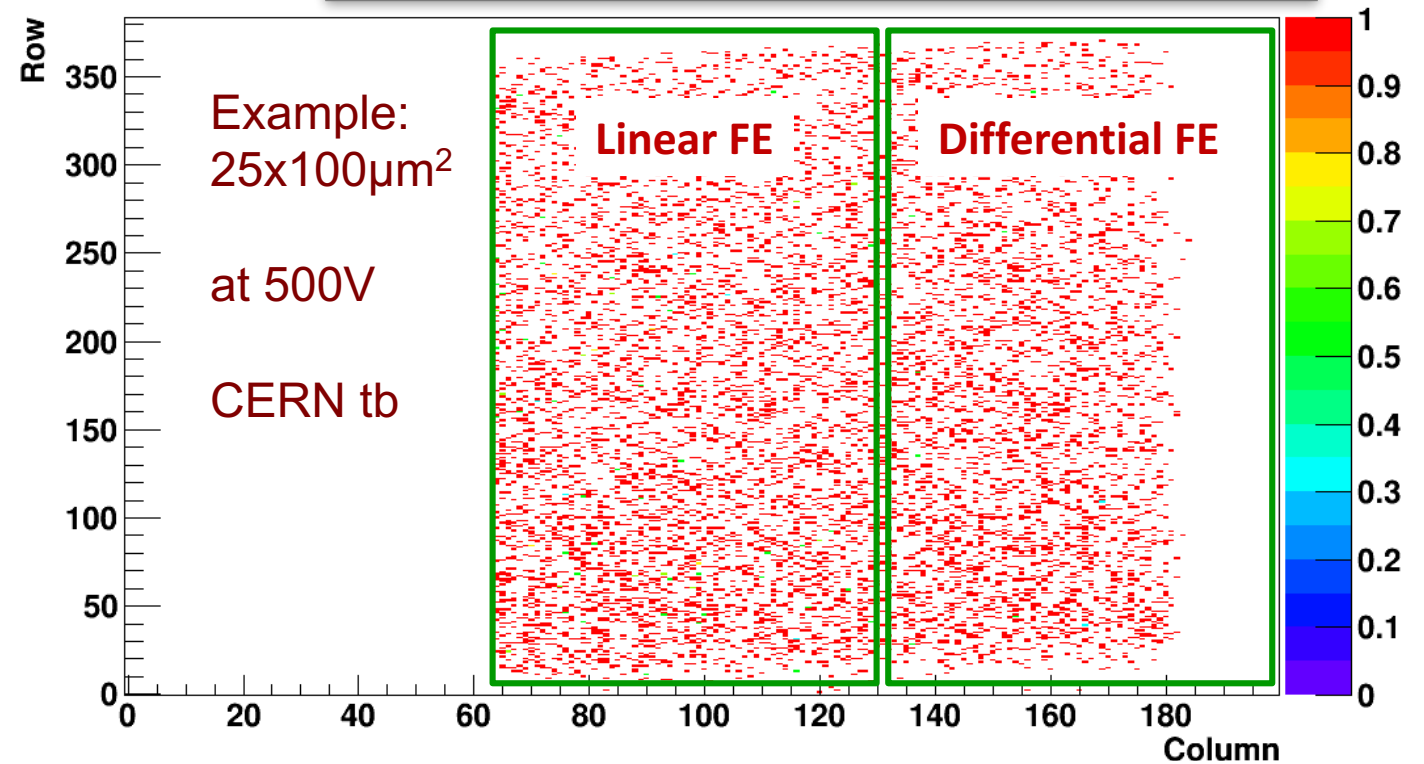
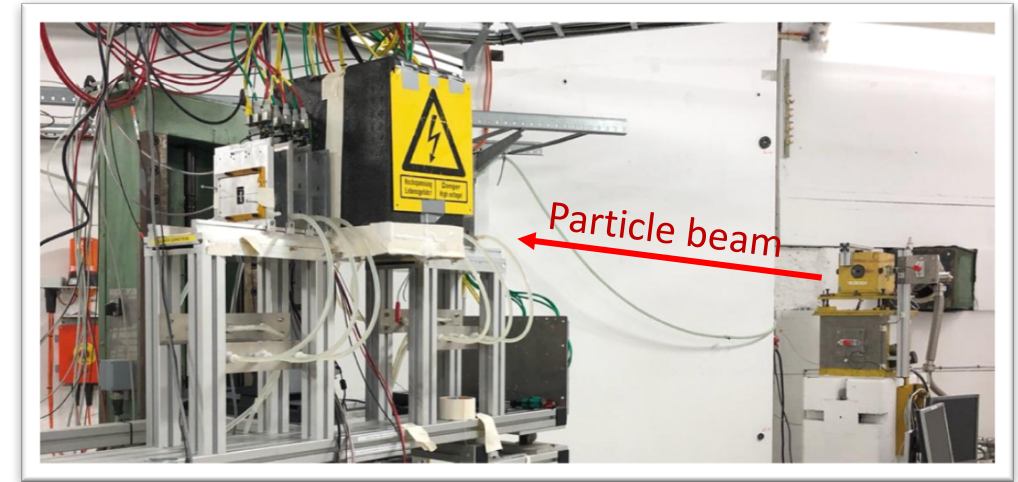
Tuning

- Tuning for RD53a chip is performed using the Bdaq53. Scanning processes is performed for each front-end flavor independently.
- Example of threshold distribution for a 25x100 μm^2 irradiated module after tuning.



Analysis regions

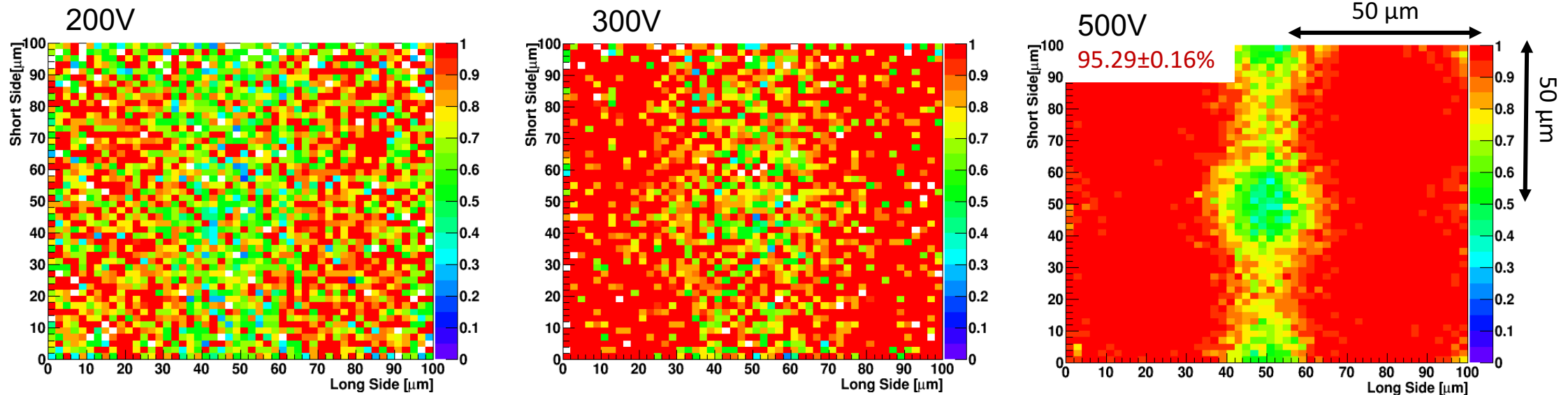
- In the testbeam setup the sensors were centered on the particle beam to cover two front-ends at the same time.
- Hit efficiency map at **500V** measured at **CERN testbeam** setup.
- Each front-end was analyzed separately using TBmon2.



In-pixel efficiency maps

Hit efficiency is defined as the fraction of reconstructed tracks crossing a module that have an associated hit in that module.

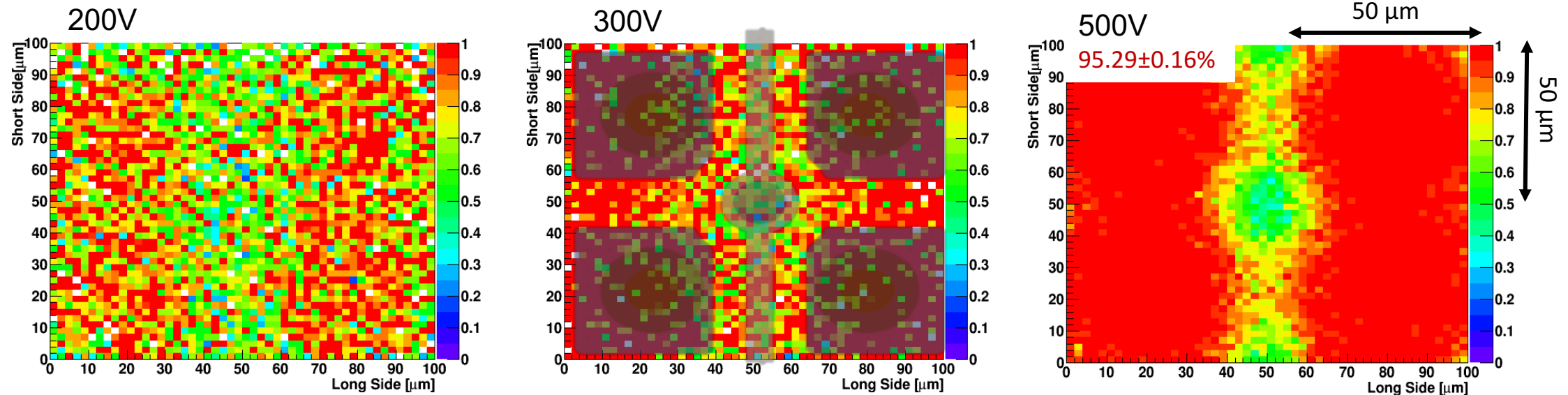
- 2x2 Pixel efficiency map shows the overall hit efficiency of the module .
- At 500V the hit efficiency is $95.29 \pm 0.16\%$.
- Significant **hit efficiency loss** is visible in the **biasing structure** region.



In-pixel efficiency maps

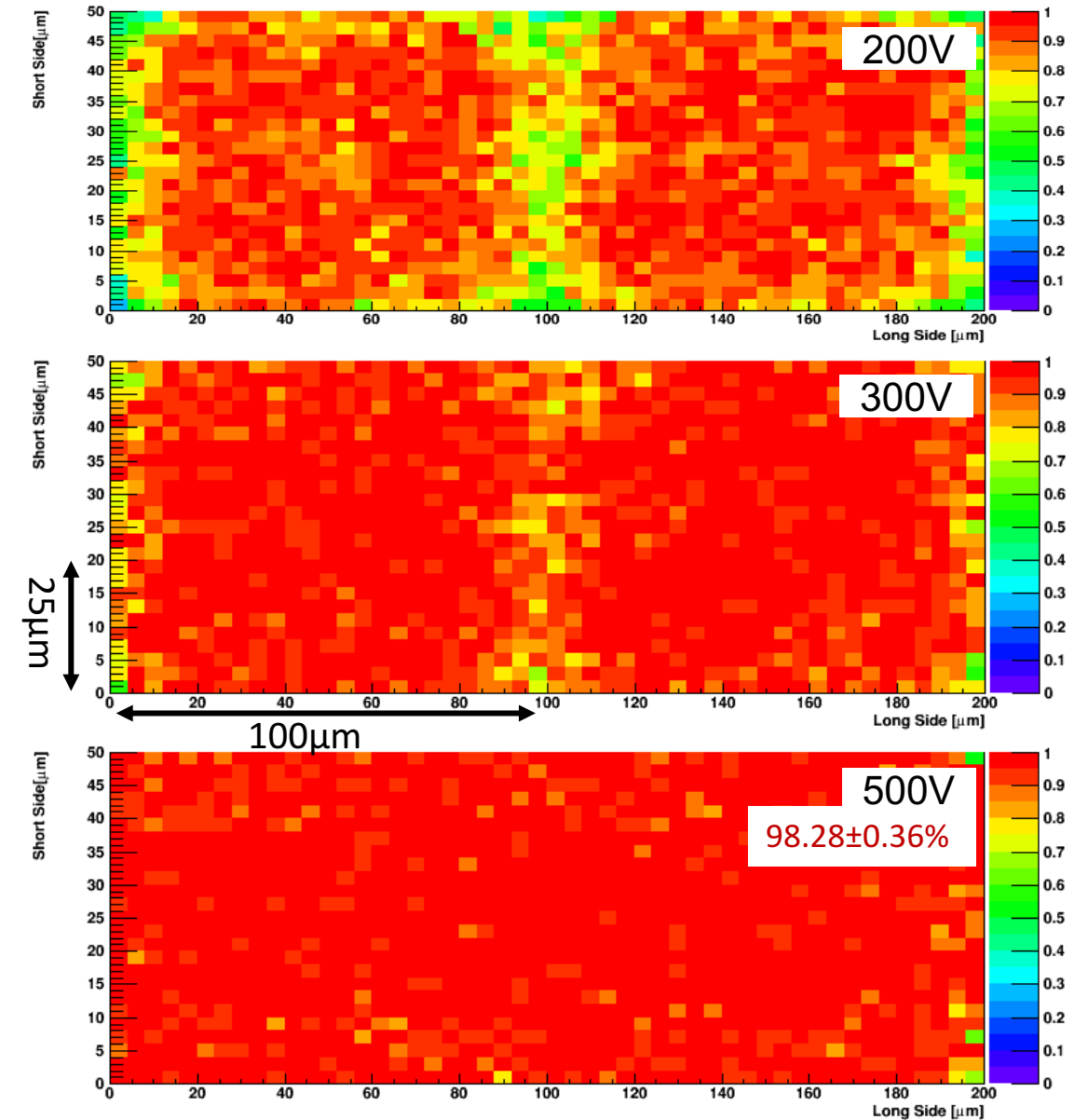
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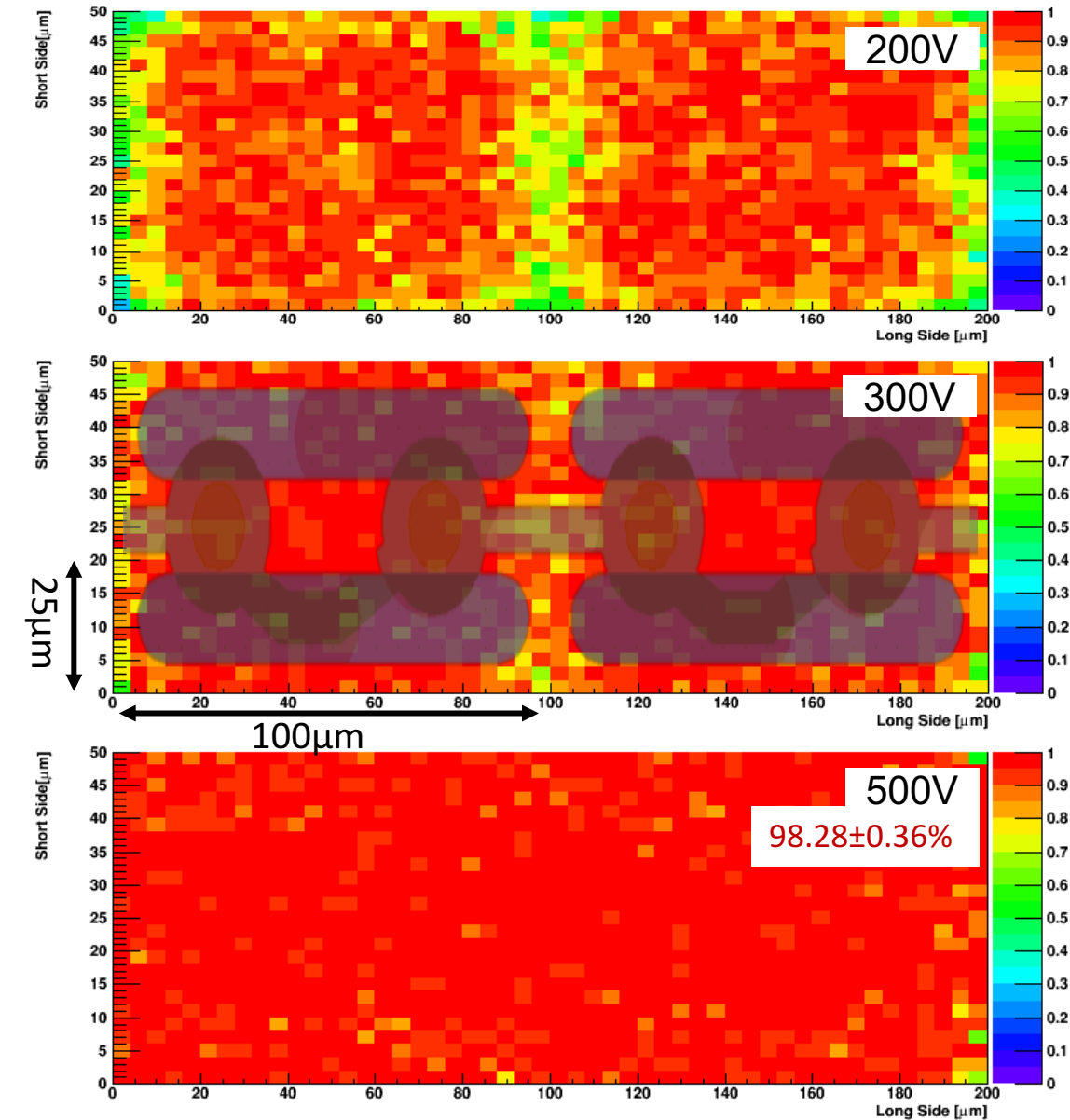
In-pixel efficiency maps

- 2x2 Pixel efficiency maps for a module with $25 \times 100 \mu\text{m}^2$ cell size and no Biasing structure. Sensor design is overlaid on the pixel map.
- At 500V the hit efficiency is $98.3 \pm 0.4\%$.
- At 500V pixel efficiency map shows **uniform efficiency** due to the no biasing structure sensor design.



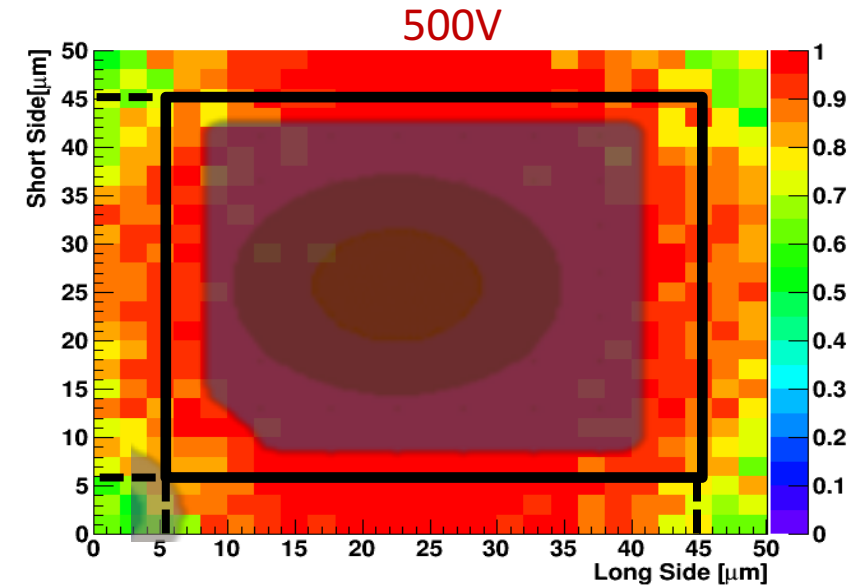
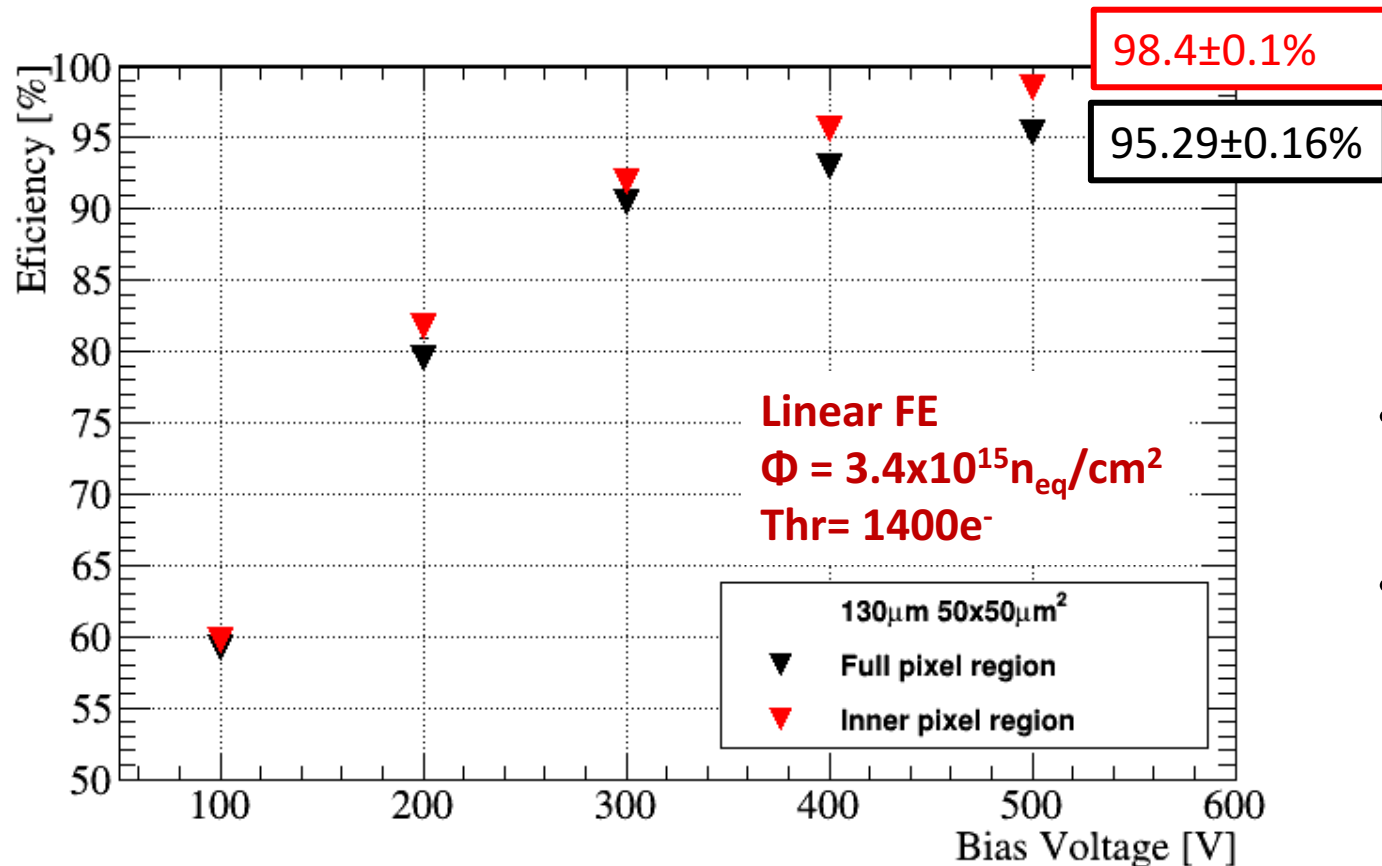
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Hit efficiency: Fiducial region

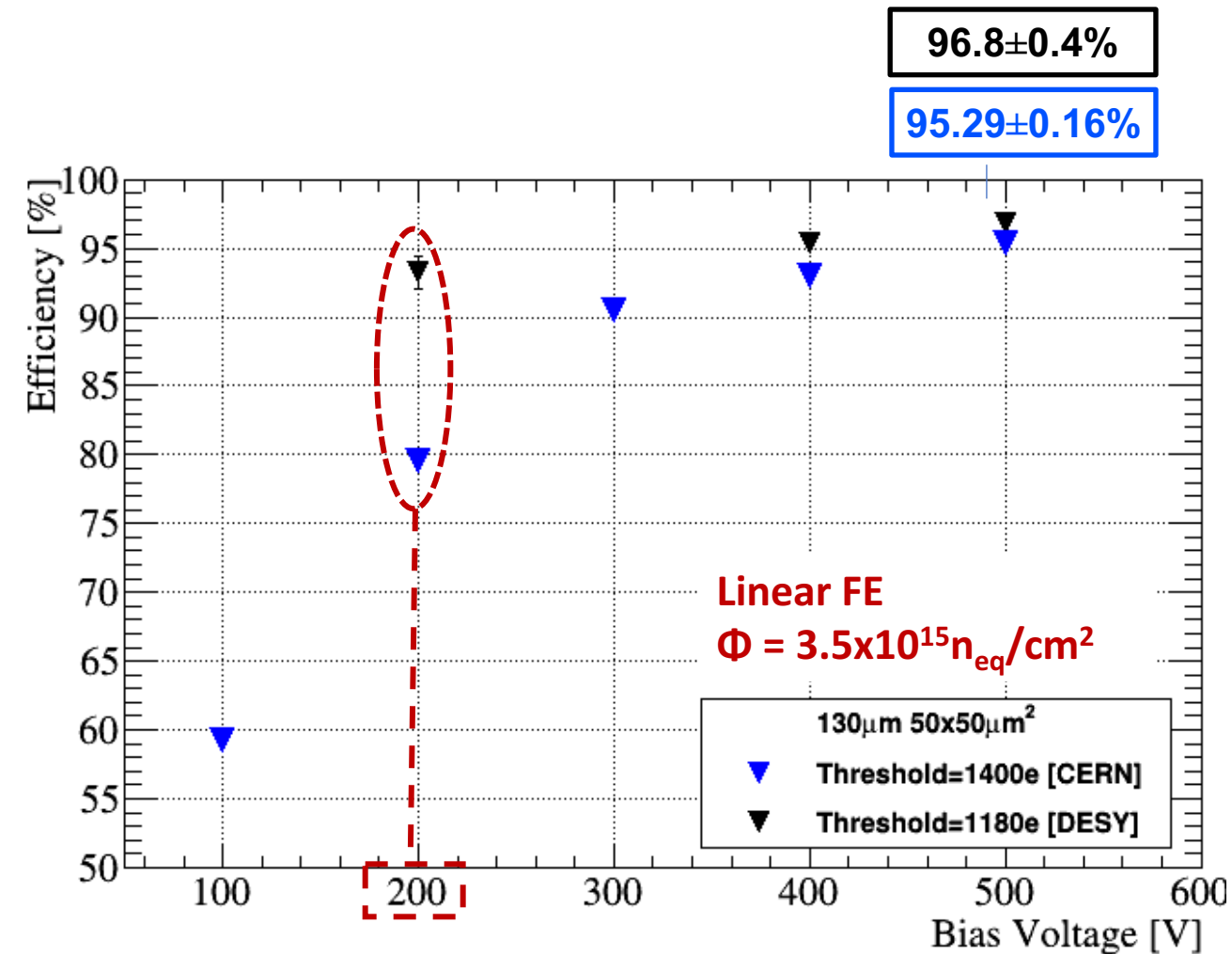
- Studying the influence of biasing structure on the hit efficiency → comparing the hit efficiency of the full pixel geometry with the core pixel.



- Analysis restricted to **Linear FE**.
- Over all hit efficiency **increases by ~3%** in the fiducial region.

Hit efficiency vs. bias voltage: Threshold effect

- Overall hit efficiency for $50 \times 50 \mu\text{m}^2$ pixel module.
- Hit efficiency vs. bias voltage measured for **Linear front-end**.
- Tuned threshold:
 - $1400e^-$ (measured at CERN October 2018)
 - $1180e^-$ (measured at DESY December 2018)
- **For lower tuned threshold value:**
 - ✓ **15% Higher hit efficiency** at 200V
 - ✓ **Earlier saturation** of hit efficiency at 400V



Hit efficiency vs. bias voltage

- Hit efficiency for an irradiated $25 \times 100 \mu\text{m}^2$ pixel module.

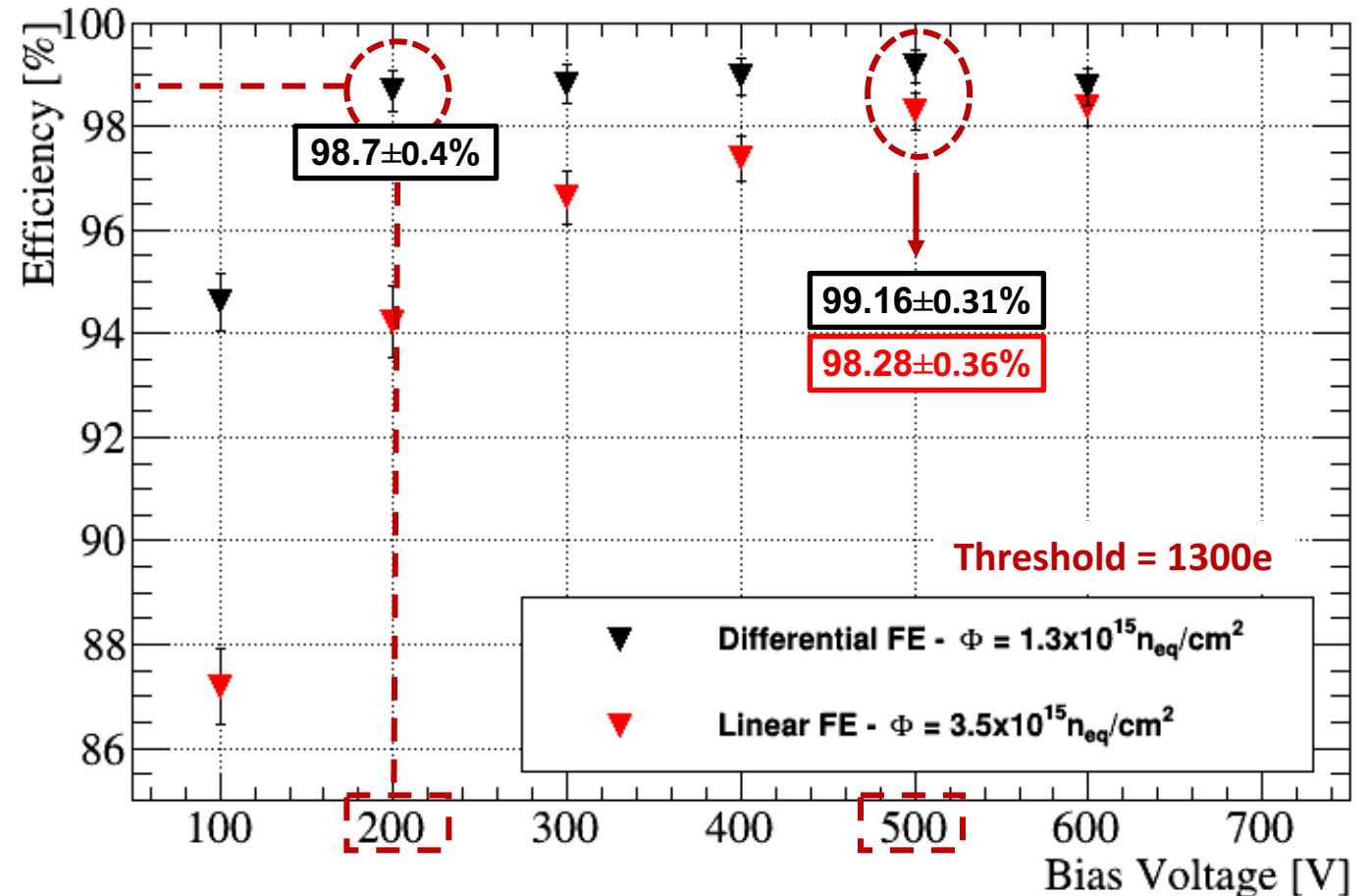
- Average fluence on:

- Differential FE $\Phi = 1.3 \times 10^{15} \text{ n}_{\text{eq}}/\text{cm}^2$
- Linear FE $\Phi = 3.5 \times 10^{15} \text{ n}_{\text{eq}}/\text{cm}^2$

- Similar tuned threshold value for both front ends of 1300e

- Hit efficiency saturation at 200V for $\Phi = 1.3 \times 10^{15} \text{ n}_{\text{eq}}/$

- Hit efficiency saturation at 500V for $\Phi = 3.5 \times 10^{15} \text{ n}_{\text{eq}}/\text{cm}^2$

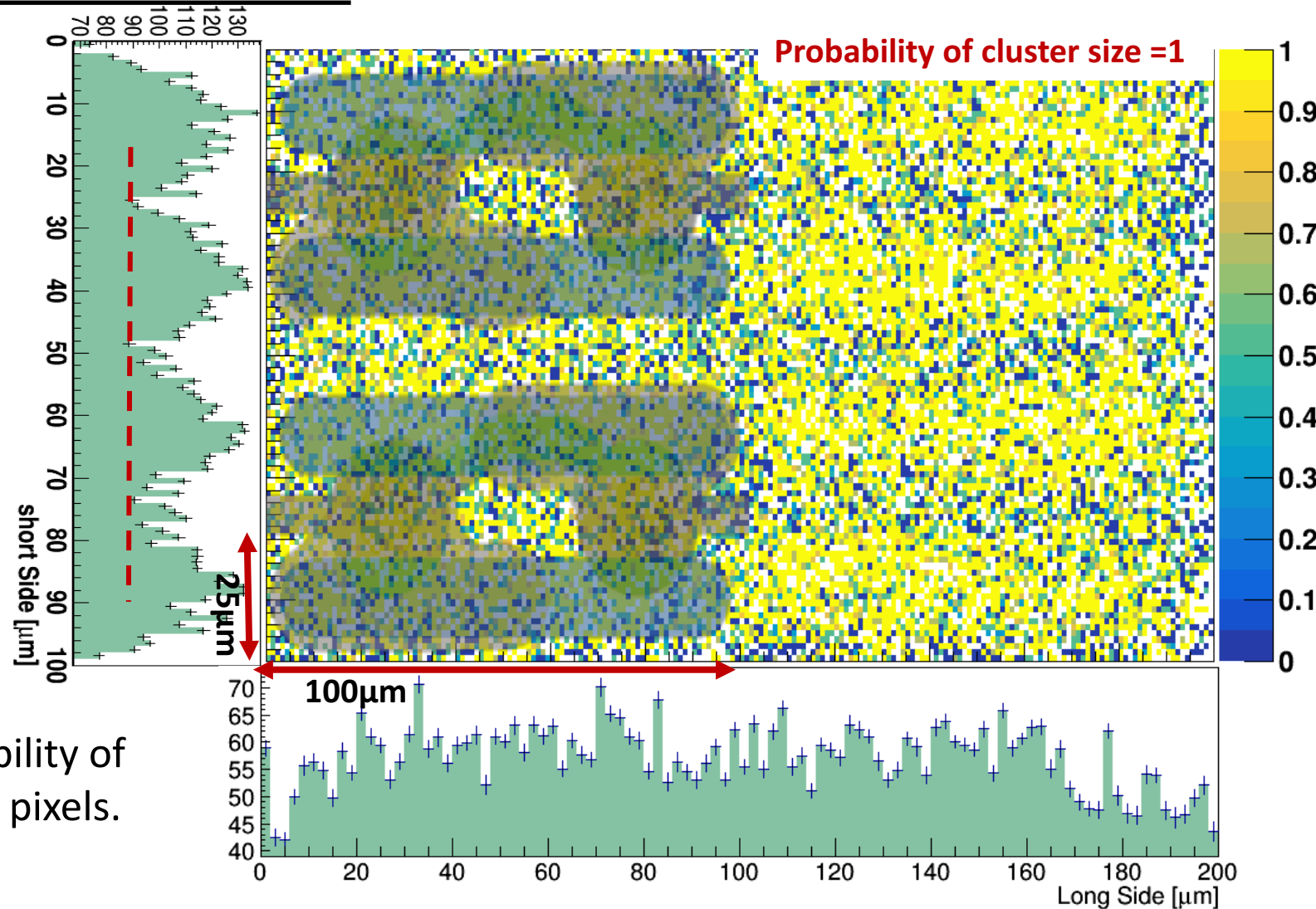


Cluster size and cross talk

- Irradiated $25 \times 100 \mu\text{m}^2$ module. Analysis region restricted to **linear FE**.
- From previous studies cross talk appears for all front ends.
 - Natalia Emriskova, RD53 Review Open Session

https://indico.cern.ch/event/769894/contributions/3229980/attachments/1765304/2865819/AFE_REVIEW_CERN_test_results.pdf

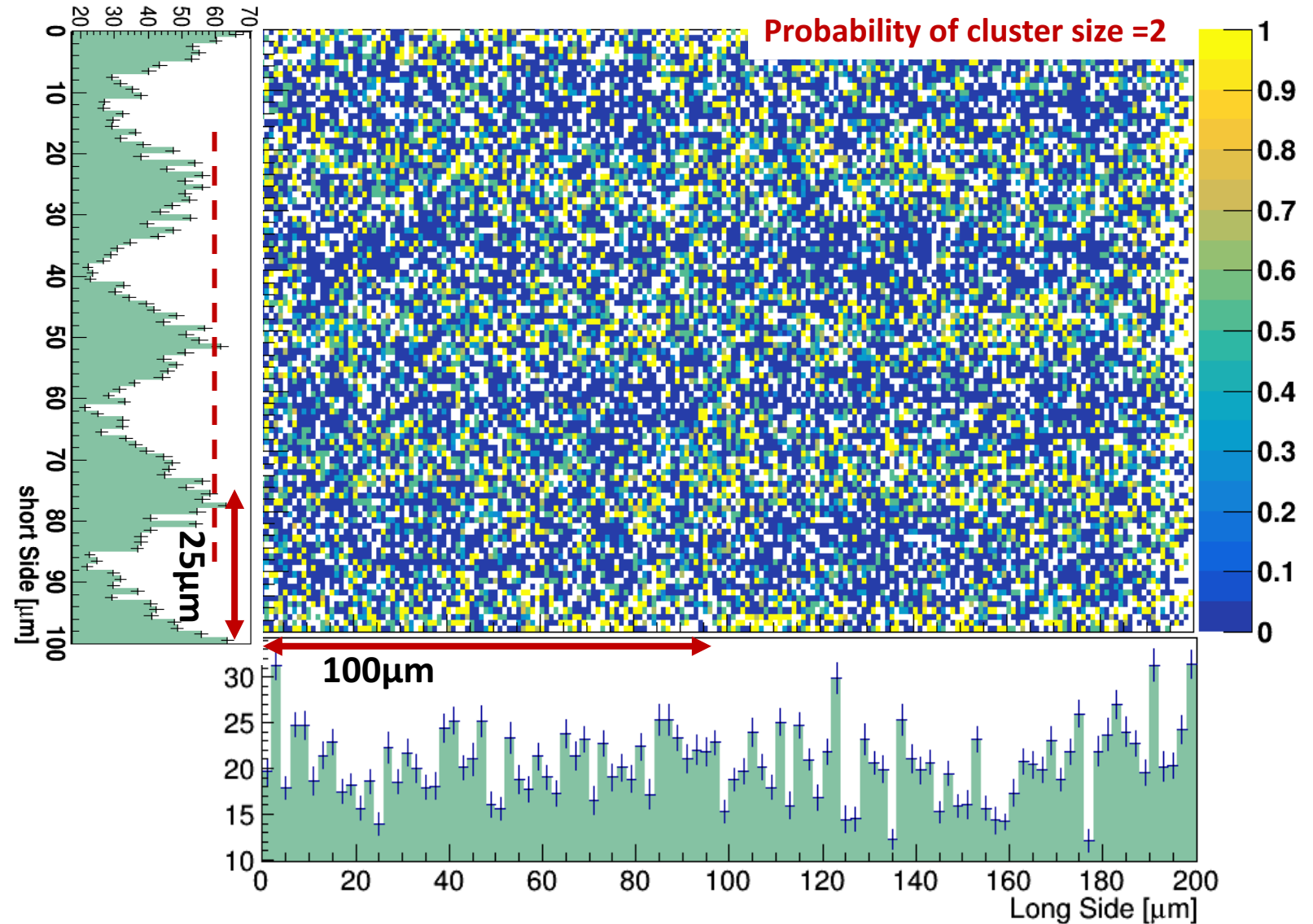
- Analysis of cluster size shows probability of cluster size >1 between neighboring pixels.



Cluster size and cross talk

- No indication of cross talk from studying the cluster size.

More statistics required



Conclusions

- At 500V, linear FE, $\Phi = 3.5 \times 10^{15} \text{ n}_{\text{eq}}/\text{cm}^2$, threshold = 1400e **with permanent biasing structure** shows hit efficiency of $95.29 \pm 0.16\%$ while when **excluding the biasing dot** the hit efficiency increases to $98.4 \pm 0.1\%$.
- 25x100 μm^2 sensor with threshold=1250e
 - Linear FE with $\Phi = 3.5 \times 10^{15} \text{ n}_{\text{eq}}/\text{cm}^2$ → hit efficiency about 98% .
 - Differential FE with $\Phi = 1.3 \times 10^{15} \text{ n}_{\text{eq}}/\text{cm}^2$ → hit efficiency about 99% .
- At 200V, irradiated module at $\Phi = 3.5 \times 10^{15} \text{ n}_{\text{eq}}/\text{cm}^2$ (linear FE) shows hit efficiency of $94.22 \pm 0.69\%$ while with lower fluence of $\Phi = 1.3 \times 10^{15} \text{ n}_{\text{eq}}/\text{cm}^2$ (diff FE) it shows **15% increase of efficiency** of $98.7 \pm 0.4\%$.
- Testbeam data (at DESY) for 25x100 μm^2 do not show indications of cross-talk → More data might be needed.

**compatible
with ITK
requirements**

Outlook

- Waiting for 2 more modules to be assembled for testbeam measurements in May 2019.
- study the performance of non-irradiated front-end flavors with lowest achievable threshold for each flavor.
- An investigation on threshold homogeneity for RD53A for non-irradiated and irradiated modules is planned in March testbeam.
- Measurements of hit efficiency as a function of **fluence**. Irradiation planned at **Karlsruhe in 2019**:
 - $\Phi = 1 \times 10^{15} n_{eq}/cm^2$
 - $\Phi = 2 \times 10^{15} n_{eq}/cm^2$
 - $\Phi = 3 \times 10^{15} n_{eq}/cm^2$
- New production of planar sensors from **FBK** arriving in few months.

Acknowledgments

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- ✓ Irradiations and testbeam supported by AIDA-2020 Project EU-INFRA Proposal no. 654168



- ✓ Many thanks to all ITk pixel testbeam community specially LAL group(Dmytro&Anestasia).